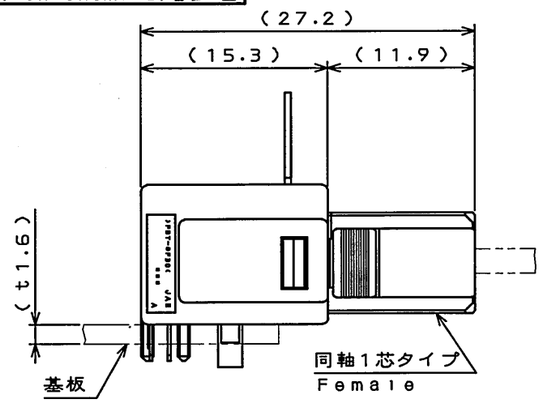
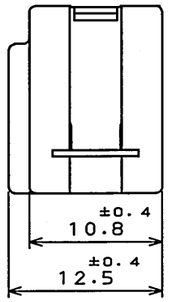
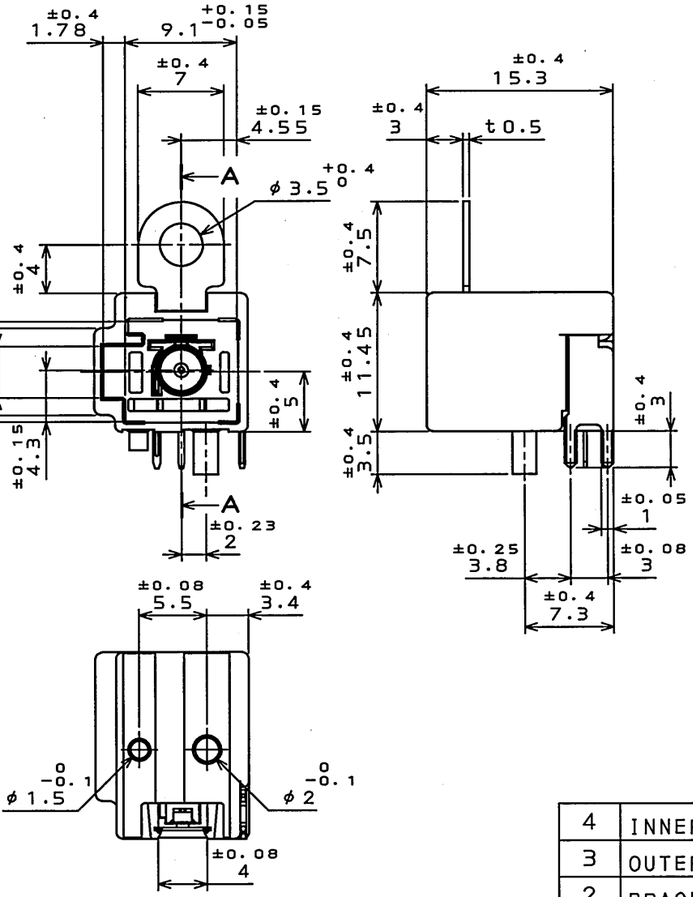
図面番号(DRAWING NO.)
SJ111024

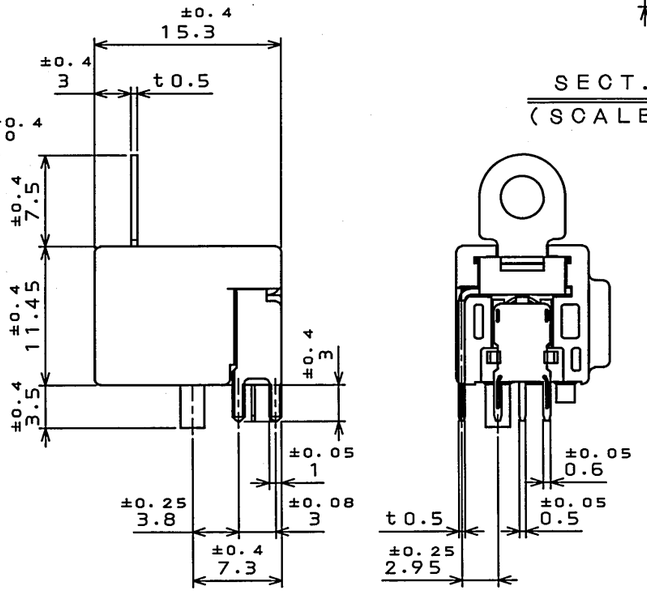
版数 REV.	年月日 DATE	DCN NO.	変更内容 DESCRIPTION	製図 DR.	担当 CHK.	査閲 APPD.	承認 APPD.

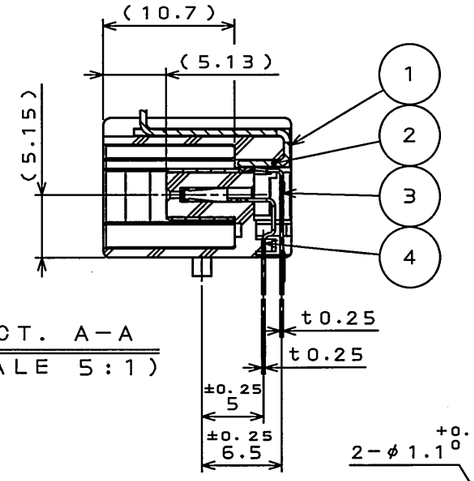


MATED CONDITION(REF.)
かん合状態図(参考)

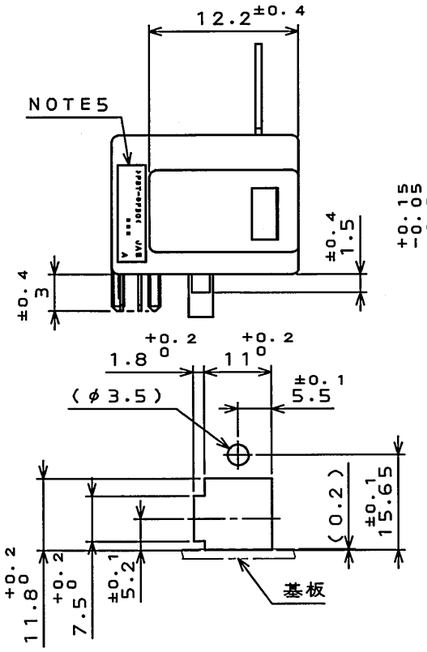




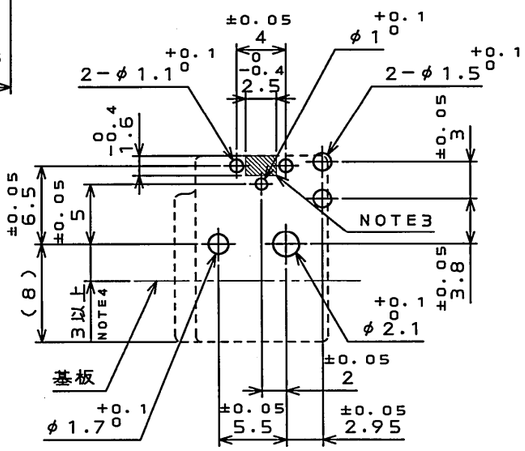




SECT. A−A
(SCALE 5:1)



PANEL HOLE PATTERNS(REF.)
パネル取付穴寸法(参考)



P.C.B. LAYOUT・MOUNTING SIDE(REF.)
基板取付穴寸法(参考・装着面)

符号 NO.	名称 DESCRIPTION	個数 QTY.	材料 MATERIAL	仕上 FINISH	備考 REMARKS
4	INNER TERMINAL	1	COPPER ALLOY	SELECTIVE GOLD PLATING OVER NICKEL, SELECTIVE TIN PLATING OVER NICKEL	
3	OUTER TERMINAL	1	COPPER ALLOY	TIN PLATING	
2	BRACKET	1	COPPER ALLOY	TIN PLATING	
1	HOUSING	1	GF PBT	(COLOR:SAKURA)	

NOTE1.APPLICABLE P.C.B THICKNESS : 1.6mm
2.APPLY THE HEAT TO MELT RIB, SO THAT THE RIB MAY STICK FIRMLY TO P.C.B. WITHOUT LEAVING SPACE BETWEEN THEM.
3.PATTERN PROHIBITION AREA(CONNECTOR MOUNTING SIDE)
4.THE DISTANCE SHALL BE MORE THAN 3mm WHEN HEATING TO MELT RIB.
5.COMPANY LOGO "JAE", MOLD CAVITY DESIGHNATOR AND MAETRIAL MARKS "PBT-GF30" IS INDICATED AS SHOWN.

注1.適合基板厚:1.6mm
2.溶着用レグは基板裏側から基板との浮きが無いよう確実に溶着し固定すること。
3.パターン禁止区域(コネクタ実装面)
4.レグ溶着時は3mm以上であること。
5.図示の位置に社標、金型マーク、材料名の表示を行う。

仕様書(SPECIFICATION)	JACS-20111
第1版(ORIGINAL DATE)	25.Nov.2010
製図 DR.	
担当 CHK.	H.MIZUSHINA
査閲 APPD.	
承認 APPD.	T. Totani
一般公差(GENERAL TOLERANCE)	寸法(DIMENSION) . ±0.8 .X ±0.4 .XX ±0.1 .XXX± / 角度(ANGLES) X° ± X°'±
尺度(SCALE)	2:1
シリーズ(SERIES)	CE2
名称(TITLE)	CE2S102D02
質量(MASS)	
日本航空電子工業株式会社 JAPAN AVIATION ELECTRONICS INDUSTRY, LTD.	
図面番号(DRAWING NO.)	SJ111024
版数(REV.)	1
SIZE	A3

JAE-CONNECTOR.COM
Reference Only

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